

## EAST Search History

| Ref # | Hits   | Search Query  | DBs   | Default Operator | Plurals | Time Stamp          |
|-------|--------|---|---|------------------|---------|---------------------|
| L1    | 2      | (wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1) and classification adj defects and specific adj process and number adj defects and photos and illumination | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/07/02<br>13:17 |
| L2    | 0      | L1 and (first and second)adj wafer  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/07/02<br>13:26 |
| L3    | 0      | L1 and (first and second)adj wafer and defect\$3  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/07/02<br>13:26 |
| L4    | 1      | L1 and @ad<"20030712"   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/07/02<br>13:28 |
| S1    | 571947 | (wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2008/12/05<br>11:27 |
| S2    | 1      | S1 and automatic and defect adj classification and teaching and knowledge adj based adj database  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2008/12/05<br>11:29 |
| S3    | 1      | automatic and defect adj classification and teaching and knowledge adj based adj database   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2008/12/05<br>11:30 |

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| S4  | 1  | S1 and defect adj classification and teaching and knowledge adj based adj database  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:30 |
| S5  | 1  | defect adj classification and teaching and knowledge adj based adj database         | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:30 |
| S6  | 2  | defect adj classification and knowledge adj based adj database                      | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:31 |
| S7  | 82 | defect and classification and knowledge adj database                                | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:31 |
| S8  | 19 | S7 and (water\$1 or semiconductor\$1 or chip\$1 or substrat\$1)                     | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:31 |
| S9  | 17 | S8 and (@ad<"20030712" or @rlad<"20030712" or @prad<"20030712" or @ptad<"20030712") | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:36 |
| S10 | 12 | S8 and @ad<"20030712"   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:36 |
| S11 | 24 | ((DIRK) near2 (SOENKSEN)).INV.  | US-PGPUB;<br>USPAT                                      | OR | ON | 2008/12/05<br>11:36 |
| S12 | 11 | ((RALF) near2 (FRIEDRICH)).INV.   | US-PGPUB;<br>USPAT                                      | OR | ON | 2008/12/05<br>11:37 |
| S13 | 1  | ((ANDREAS) near2 (DRAEGER)).INV.  | US-PGPUB;<br>USPAT                                      | OR | ON | 2008/12/05<br>11:37 |
| S14 | 2  | ((DETLEF) near2 (SCHUPP)).INV.  | US-PGPUB;<br>USPAT                                      | OR | ON | 2008/12/05<br>11:37 |

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| S16 | 2      | ((THIN) near2 ("VAN LUU")).INV.                              | US-PGPUB;<br>USPAT                                     | OR | ON | 2008/12/05<br>11:39 |
| S17 | 3      | ((WOLFGANG) near2 (LANGER)).INV.                             | US-PGPUB;<br>USPAT                                     | OR | ON | 2008/12/05<br>11:39 |
| S18 | 0      | S11 and defect and classification and knowledge adj database | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>BM_TDB | OR | ON | 2008/12/05<br>11:40 |
| S19 | 0      | S11 and defect and classification and knowledge adj database | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>BM_TDB | OR | ON | 2008/12/05<br>11:40 |
| S20 | 0      | S11 and defect and classification and knowledge adj database | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>BM_TDB | OR | ON | 2008/12/05<br>11:41 |
| S21 | 0      | S12 and defect and classification and knowledge adj database | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>BM_TDB | OR | ON | 2008/12/05<br>11:41 |
| S22 | 0      | S13 and defect and classification and knowledge adj database | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>BM_TDB | OR | ON | 2008/12/05<br>11:43 |
| S23 | 3      | S10 and descriptor   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>BM_TDB | OR | ON | 2008/12/05<br>11:46 |
| S24 | 638382 | S23 and select\$3 and review and data file                   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>BM_TDB | OR | ON | 2008/12/05<br>11:47 |
| S25 | 0      | S23 and select\$3 and review and data adj file               | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>BM_TDB | OR | ON | 2008/12/05<br>11:47 |

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| S26 | 18 | S7 and select\$3 and review and data adj file | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:48 |
| S27 | 0  | S26 and parameters and learning adj node      | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:49 |
| S28 | 0  | S26 and parameters and learning adj mode      | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:49 |
| S29 | 17 | S26 and parameters                            | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:49 |
| S30 | 2  | S1 and S7 and S24 and S29                     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:56 |
| S31 | 2  | S30 and @ad<"20030712"                        | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:56 |
| S32 | 18 | S7 and S26                                    | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:57 |
| S33 | 16 | S32 and @ad<"20030712"                        | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>11:58 |
| S34 | 20 | S1 and automatic and defect adj recognition   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>12:00 |

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| S35 | 638382 | S34 and select\$3 and review and data file | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>12:01 |
| S36 | 4      | S34 and descriptor                         | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>12:33 |
| S37 | 1      | S34 and learning adj mode                  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>12:34 |
| S38 | 0      | S37 and @ad<"20030712"                     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>12:34 |
| S39 | 16     | S34 and @ad<"20030712"                     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>12:35 |
| S40 | 0      | S39 and learning adj mode                  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>12:35 |
| S41 | 2      | S39 and learning                           | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>12:35 |
| S42 | 16     | S26 and @ad<"20030712"                     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>12:39 |
| S43 | 0      | S42 and learning adj mode                  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>12:40 |

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| S44 | 0   | S42 and learning near mode   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/05<br>12:40 |
| S45 | 0   | S42 and learning near3 mode  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/05<br>12:40 |
| S46 | 11  | S42 and descriptor   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/05<br>12:40 |
| S47 | 598 | S1 and select\$3 and review and data adj file  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/05<br>12:44 |
| S48 | 340 | S47 and @ad<"20030712"   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/05<br>12:44 |
| S49 | 1   | S48 and input and user and learning adj mode   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/05<br>12:45 |
| S50 | 1   | S48 and learning adj mode  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/05<br>12:46 |
| S51 | 4   | S48 and alignment adj procedure  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/05<br>12:46 |
| S52 | 0   | S8 and automatic adj defect and recognition and(detect\$3 or determining)same (defect or flaw or fault)same(assign\$3 or test\$3 or evaluat\$3)same descriptor | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/05<br>13:02 |

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| S53 | 0  | S48 and automatic adj defect and recognition and (detect\$3 or determining) same (defect or flaw or fault) same (assign\$3 or test\$3 or evaluat\$3) same descriptor | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>13:02 |
| S54 | 1  | automatic adj defect and recognition and (detect\$3 or determining) same (defect or flaw or fault) same (assign\$3 or test\$3 or evaluat\$3) same descriptor         | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>13:02 |
| S55 | 11 | automatic adj defect and recognition and (detect\$3 or determining) and (defect or flaw or fault) and (assign\$3 or test\$3 or evaluat\$3) and descriptor            | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>13:03 |
| S56 | 5  | S55 and @ad<"20030712"   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>13:03 |
| S57 | 1  | S56 and learning adj mode  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>13:03 |
| S58 | 0  | S57 and edit adj recipe  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>13:05 |
| S59 | 0  | S57 and edit   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>13:05 |
| S60 | 0  | S57 and memory adj circuits  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>13:07 |
| S61 | 1  | S57 and circuits   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>13:07 |

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| S62 | 0      | S61 and logic adj circuits                                   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>13:08 |
| S63 | 0      | S61 and blank adj wafer\$1                                   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>13:08 |
| S64 | 1      | S66 and learning adj mode                                    | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/05<br>14:02 |
| S65 | 571947 | (wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:12 |
| S66 | 2      | S65 and select\$3 and review adj data adj file               | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:13 |
| S67 | 2      | S65 and review adj data adj file                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:13 |
| S68 | 638    | S65 and review and data adj file                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:14 |
| S69 | 134    | S65 and review same data adj file                            | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:14 |
| S70 | 0      | S69 and defect and classification and knowledge adj database | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:15 |



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| S71 | 0  | S69 and classification and knowledge adj database  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:15 |
| S72 | 1  | S69 and classification and knowledge near3 database  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:15 |
| S73 | 11 | S68 and classification and knowledge near3 database  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:15 |
| S74 | 5  | S73 and @ad<"20030712"   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:16 |
| S75 | 5  | S74 and review and data adj file   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:16 |
| S76 | 1  | S75 and (user or operator or human)and page and learning adj mode  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:17 |
| S77 | 1  | S75 and (user or operator or human)and learning adj mode   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:17 |
| S78 | 9  | S68 and(detect\$3 or determining) and (defect or fault or flaw)and classification and knowledge near3 database | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:19 |
| S79 | 13 | learning and(knowledge-based or knowledge adj based)and database and automatic and defect adj classification   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:21 |

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| S80 | 10     | S79 and @ad<"20030712"  | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:21 |
| S81 | 0      | S80 and review and data adj file                                | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:21 |
| S82 | 1      | S80 and data adj file   | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:22 |
| S83 | 8      | S80 and(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1) | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:24 |
| S84 | 8      | S83 and @ad<"20030712"  | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:24 |
| S85 | 6      | S84 and descriptor  | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:43 |
| S86 | 5      | S84 and descriptor adj (defect or fault or flaw)                | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/06<br>11:46 |
| S87 | 573639 | (wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)        | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:04 |
| S88 | 19     | S87 and defect and classification and knowledge adj database    | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:05 |

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| S89 | 640949 | S88 and select\$3 and review and data file  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:05 |
| S90 | 2      | S88 and select\$3 and review and data adj file  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:05 |
| S91 | 8      | S87 and display adj thumbnails  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:07 |
| S92 | 2      | S91 and @ad<"20030712"  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:07 |
| S93 | 0      | S92 and descriptor  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:15 |
| S94 | 8      | S91 and parameters  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:27 |
| S95 | 1      | S94 and automatic adj defect and recognition and(detect\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3) | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:29 |
| S96 | 2      | S92 and display adj thumbnails  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:30 |
| S97 | 2      | S96 and parameters  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:30 |

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| S98  | 0 | S97 and circuits  | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:31 |
| S99  | 0 | S97 and defect and (classification or classifier or classify)     | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:32 |
| S100 | 0 | S97 and(classification or classifier or classify or grouping)     | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:33 |
| S101 | 0 | S97 and intensity   | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:33 |
| S102 | 2 | S97 and (intensity or contrast or brightness)                     | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:34 |
| S103 | 2 | S102 and(illumination or source or light)                         | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:34 |
| S104 | 2 | S103 and(blank adj water\$1 or water\$1)                          | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:36 |
| S105 | 2 | S104 and(polymer or layer or oxide adj layer or contact or metal) | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:38 |
| S106 | 0 | S105 and lens   | US-PG&UB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/17<br>19:39 |

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|------|---|--|---|----|----|---------------------|
| S107 | 0 | S105 and focus   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/17<br>19:39 |
| S108 | 0 | S105 and magnificat\$3                                 | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/17<br>19:40 |
| S109 | 2 | S105 and @ack<"20030712"                               | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/17<br>19:40 |
| S110 | 2 | S109 and select\$3 adj recipe                          | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/17<br>19:41 |
| S111 | 2 | "6973209".pn.  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/19<br>15:40 |
| S112 | 0 | S111 and alignment                                     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/19<br>15:40 |
| S113 | 1 | S111 and align\$3                                      | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/19<br>15:40 |
| S114 | 0 | S111 and align\$3 same light                           | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/19<br>15:41 |
| S115 | 1 | S111 and align\$3 and(light or source or illuminat\$3) | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/19<br>15:41 |

|      |   |  |   |    |    |                     |
|------|---|--|---|----|----|---------------------|
| S116 | 1 | S115 and adjusting                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:42 |
| S117 | 0 | S116 and optimal adj intensity                 | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:42 |
| S118 | 1 | S116 and optimal                               | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:42 |
| S119 | 0 | S118 and intensity                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:42 |
| S120 | 1 | S118 and parameters                            | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:43 |
| S121 | 1 | S120 and algorithm                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:46 |
| S122 | 1 | S121 and automatic                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:47 |
| S123 | 0 | S122 and intensity                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:47 |
| S124 | 1 | S122 and (intensity or contrast or brightness) | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:47 |

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|------|----|--|---|----|----|---------------------|
| S125 | 0  | S124 and text adj image\$1                           | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:48 |
| S126 | 0  | S124 and text  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:48 |
| S127 | 1  | S124 and recipe                                      | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:49 |
| S128 | 0  | S127 and review                                      | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:49 |
| S129 | 1  | S127 and dictionary                                  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:49 |
| S130 | 1  | S129 and registered                                  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:50 |
| S131 | 1  | S130 and drag  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>15:51 |
| S132 | 82 | defect and classification and knowledge adj database | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>16:09 |
| S133 | 18 | S132 and select\$3 and review and data adj file      | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/19<br>16:09 |

|      |    |  |   |    |    |                     |
|------|----|--|---|----|----|---------------------|
| S134 | 16 | S133 and @ad< "20030712"                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/19<br>16:09 |
| S135 | 0  | S132 and select\$3 same review adj data              | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/19<br>16:13 |
| S136 | 5  | S132 and review adj data                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/19<br>16:13 |
| S137 | 3  | S136 and @ad< "20030712"                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/19<br>16:14 |
| S138 | 1  | S137 and descriptors                                 | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/19<br>16:19 |
| S139 | 0  | S137 and defect adj descriptors                      | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/19<br>16:20 |
| S140 | 82 | defect and classification and knowledge adj database | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/30<br>11:44 |
| S141 | 5  | S140 and review adj data                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/30<br>11:44 |
| S142 | 3  | S141 and @ad< "20030712"                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/30<br>11:44 |



|      |     |  |   |    |    |                     |
|------|-----|--|---|----|----|---------------------|
| SI43 | 2   | SI42 and(wafer\$1 or semicondutor\$1 or chip\$1 or subtrat\$1) | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/30<br>11:45 |
| SI44 | 3   | "6408219".pn.  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/30<br>11:46 |
| SI45 | 1   | SI44 and review adj data                                       | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/30<br>11:47 |
| SI46 | 1   | SI44 and select\$3   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/30<br>11:48 |
| SI47 | 732 | select\$3 same review adj data                                 | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/30<br>11:50 |
| SI48 | 62  | SI47 and(wafer\$1 or semicondutor\$1 or chip\$1 or subtrat\$1) | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/30<br>11:50 |
| SI49 | 0   | SI48 and defect and classification and knowledge adj database  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/30<br>11:50 |
| SI50 | 0   | SI48 and classification and knowledge adj database             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/30<br>11:50 |
| SI51 | 14  | SI48 and @ad< "20030712"                                       | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/30<br>11:51 |

|      |   |   |   |    |    |                     |
|------|---|---|---|----|----|---------------------|
| S152 | 0 | S151 and display adj thumbnails                                   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/30<br>11:51 |
| S153 | 0 | S151 and display and thumbnails                                   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/30<br>11:52 |
| S154 | 0 | S151 and thumbnails   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/30<br>11:52 |
| S155 | 0 | S151 and automatic and defect adj recognition                     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/30<br>12:12 |
| S156 | 0 | S151 and select\$3 adj recipe                                     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/30<br>12:13 |
| S157 | 1 | S151 and align\$3 and(light or source or illuminat\$3)            | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/30<br>12:13 |
| S158 | 0 | S157 and(user or operator or human)and page and learning adj mode | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/30<br>12:16 |
| S159 | 0 | S157 and descriptors  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/30<br>12:16 |
| S160 | 0 | S157 and parameters   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/30<br>12:36 |

|      |        |  |   |    |    |                     |
|------|--------|--|---|----|----|---------------------|
| SI61 | 11     | automatic adj defect and recognition and(detect\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3)and descriptor          | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>15:58 |
| SI62 | 5      | SI61 and @ad< "20030712"   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>15:58 |
| SI63 | 1      | SI62 and learning adj mode   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>15:58 |
| SI64 | 0      | SI63 and memory adj circuits   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>15:58 |
| SI65 | 575216 | (wafer\$1 or semiconductor\$1 or chip\$1 or subtrat\$1)  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>15:58 |
| SI66 | 10     | SI65 and automatic adj defect and recognition and(detect\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3)and descriptor | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>15:59 |
| SI67 | 643423 | SI66 and select\$3 and review and data file  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>15:59 |
| SI68 | 1      | SI66 and select\$3 and review and data adj file  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>16:00 |
| SI69 | 0      | SI68 and @ad< "20030712"   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>16:00 |

|      |      |                              |   |    |    |                     |
|------|------|------------------------------|---|----|----|---------------------|
| S170 | 1    | S166 and memory adj circuits | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:00 |
| S171 | 0    | S170 and @ad< "20030712"     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:01 |
| S172 | 4    | S166 and @ad< "20030712"     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:01 |
| S173 | 0    | S172 and memory adj circuits | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:01 |
| S174 | 7745 | S165 and memory adj circuits | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:01 |
| S175 | 2341 | S174 and parameters          | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:01 |
| S176 | 775  | S175 and logic adj circuits  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:02 |
| S177 | 9    | S176 and blank adj wafer     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:02 |
| S178 | 8    | S177 and @ad< "20030712"     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:03 |

|      |       |                            |   |    |    |                     |
|------|-------|----------------------------|---|----|----|---------------------|
| S179 | 0     | S178 and resist            | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:03 |
| S180 | 0     | S178 and photo adj resist  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:03 |
| S181 | 0     | S178 and polymer adj layer | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:04 |
| S182 | 51765 | polymer adj layer          | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:04 |
| S183 | 33269 | S182 and @ad< "20030712"   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:04 |
| S184 | 2388  | S183 and oxide adj layer   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:05 |
| S185 | 1703  | S184 and contact           | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:05 |
| S186 | 16332 | S183 and contact           | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:05 |
| S187 | 10    | S186 and metal adj later   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/12/31<br>16:06 |

|      |   |  |   |    |    |                     |
|------|---|--|---|----|----|---------------------|
| S188 | 1 | S187 and parameters                                    | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>16:06 |
| S189 | 1 | S188 and @ad< "20030712"                               | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>16:06 |
| S190 | 1 | S189 and(intensity or contrast or brightness)          | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>16:07 |
| S191 | 0 | S190 and align\$3 and(light or source or illuminat\$3) | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>16:07 |
| S192 | 1 | S190 and(light or source or illuminat\$3)              | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>16:07 |
| S193 | 0 | S192 and magnificat\$3                                 | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>16:08 |
| S194 | 0 | S192 and lens  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>16:08 |
| S195 | 0 | S192 and histogram                                     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>16:08 |
| S196 | 0 | S195 and focus\$3                                      | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2008/12/31<br>16:12 |

|      |       |   |   |    |    |                     |
|------|-------|---|---|----|----|---------------------|
| S197 | 51832 | polymer adj layer                             | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:04 |
| S198 | 33269 | S197 and @ad<"20030712"                       | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:04 |
| S199 | 16332 | S198 and contact                              | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:04 |
| S200 | 10    | S199 and metal adj later                      | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:04 |
| S201 | 1     | S200 and parameters                           | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:04 |
| S202 | 1     | S201 and @ad<"20030712"                       | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:04 |
| S203 | 1     | S202 and(intensity or contrast or brightness) | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:04 |
| S204 | 1     | S203 and(light or source or illuminat\$3)     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:04 |
| S205 | 0     | S204 and metal adj layer                      | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:05 |

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|------|--------|------------------------------------|---|----|----|---------------------|
| S206 | 1      | S204 and metal                     | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/02<br>14:06 |
| S207 | 0      | S206 and bright adj field          | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/02<br>14:07 |
| S208 | 0      | S206 and bright                    | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/02<br>14:07 |
| S209 | 1      | S206 and (UV or DUV)               | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/02<br>14:08 |
| S210 | 0      | S209 and lens                      | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/02<br>14:08 |
| S211 | 0      | S209 and intensity                 | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/02<br>14:09 |
| S212 | 1      | S209 and contrast                  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/02<br>14:10 |
| S213 | 0      | S212 and histogram                 | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/02<br>14:10 |
| S214 | 795256 | select\$3 and review and data file | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/02<br>14:12 |



|      |      |                            |   |    |    |                     |
|------|------|----------------------------|---|----|----|---------------------|
| S215 | 2665 | S214 and polymer adj layer | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:13 |
| S216 | 12   | S215 and bright adj field  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:13 |
| S217 | 9    | S216 and (UV or DUV)       | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:13 |
| S218 | 3    | S217 and @ack<"20030712"   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:13 |
| S219 | 3    | S218 and intensity         | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:13 |
| S220 | 0    | S219 and histogram         | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:14 |
| S221 | 0    | S219 and metal adj layer   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:14 |
| S222 | 0    | S219 and lens              | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:14 |
| S223 | 4    | S216 and lens              | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/01/02<br>14:15 |

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| S224 | 0      | S223 and @ad< "20030712"  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/02<br>14:15 |
| S225 | 0      | S223 and @ad< "20030712"  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/02<br>14:15 |
| S226 | 5025   | 382/149,145,224,159,100,141,155,181.CCL.S.                            | USPAT   | OR | ON | 2009/06/29<br>11:58 |
| S227 | 4478   | 715/774,835,837,764,841,210,839,762,809,804,973,250,866,708.CCL.S.    | USPAT   | OR | ON | 2009/06/29<br>12:01 |
| S228 | 1453   | 719/310,315.CCL.S.  | USPAT   | OR | ON | 2009/06/29<br>12:01 |
| S229 | 355    | 714/E11.21.CCL.S.   | USPAT   | OR | ON | 2009/06/29<br>12:02 |
| S230 | 1846   | 356/237.1,237.2.CCL.S.  | USPAT   | OR | ON | 2009/06/29<br>12:03 |
| S231 | 834    | 702/35,1,33.CCL.S.  | USPAT   | OR | ON | 2009/06/29<br>12:04 |
| S232 | 599018 | (wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)              | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>12:29 |
| S233 | 125    | S232 and user adj select\$3 and review and data adj file              | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>12:32 |
| S234 | 3      | S233 and input adj user and page and learning adj mode and parameters | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>12:34 |
| S235 | 4      | S233 and input and user and page and learning adj mode and parameters | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>12:37 |

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| S236 | 4  | S233 and learning adj mode and parameters   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>12:55 |
| S237 | 1  | S233 and automatic adj defect and recognition and(detect\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3)and descriptor  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>12:58 |
| S238 | 11 | automatic adj defect and recognition and(detect\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3)and descriptor   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>12:59 |
| S239 | 10 | S238 and(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>12:59 |
| S240 | 1  | S239 and user adj select\$3 and review and data adj file  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>13:00 |
| S241 | 1  | S239 and user adj select\$3 and review adj data   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>13:00 |
| S242 | 3  | automatic adj defect and recognition and(detect\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3 or accept\$3)and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or cod or camera)and (illumination or source or light or optimal adj intensity or light adj intensity)                                       | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>13:12 |
| S243 | 3  | automatic adj defect and recognition and(detect\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3 or accept\$3)and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or cod or camera)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast) | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>13:16 |
| S244 | 0  | S243 and(@ad<"20030712" or @rad<"20030712" or @prad<"20030712" or @ptad<"20030712")   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>13:17 |

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|------|-----|---|-------|----|----|---------------------|
| S246 | 781 | S226 and(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)  | USPAT | OR | ON | 2009/06/29<br>13:19 |
| S247 | 3   | S246 and user adj select\$3 and review and data adj file  | USPAT | OR | ON | 2009/06/29<br>13:19 |
| S248 | 27  | S246 and user adj select\$3 and review and(storage or stored or memory or data adj file)  | USPAT | OR | ON | 2009/06/29<br>13:20 |
| S249 | 0   | S248 and input and user and page and learning adj mode and parameters   | USPAT | OR | ON | 2009/06/29<br>13:21 |
| S251 | 0   | S248 and automatic adj defect and recognition and(detected\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluate\$3 or accept\$3)and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or ccd or camera)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast) | USPAT | OR | ON | 2009/06/29<br>13:23 |
| S252 | 0   | S248 and automatic adj defect and recognition and(detected\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluate\$3 or accept\$3)and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or ccd or camera)and (illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast)             | USPAT | OR | ON | 2009/06/29<br>13:24 |
| S253 | 2   | S248 and automatic adj defect and recognition and(detected\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluate\$3 or accept\$3)  | USPAT | OR | ON | 2009/06/29<br>13:25 |
| S254 | 2   | S253 and(@ad<"20030712" or @inad<"20030712" or @prad<"20030712" or @optad<"20030712")   | USPAT | OR | ON | 2009/06/29<br>13:28 |
| S255 | 0   | S253 and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or ccd or camera)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast)  | USPAT | OR | ON | 2009/06/29<br>13:32 |
| S256 | 0   | S253 and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or ccd or camera)and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast)   | USPAT | OR | ON | 2009/06/29<br>13:43 |
| S257 | 0   | S253 and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or ccd or camera)and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast)and(detected\$3 or determining)and(defect or flaw or fault)  | USPAT | OR | ON | 2009/06/29<br>13:46 |
| S258 | 18  | S227 and(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)  | USPAT | OR | ON | 2009/06/29<br>13:48 |
| S259 | 4   | S258 and user adj select\$3 and review and(storage or stored or memory or data adj file)  | USPAT | OR | ON | 2009/06/29<br>13:48 |
| S260 | 0   | S259 and automatic adj defect and recognition and(detected\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluate\$3 or accept\$3)  | USPAT | OR | ON | 2009/06/29<br>13:48 |
| S261 | 0   | S259 and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or ccd or camera)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast)  | USPAT | OR | ON | 2009/06/29<br>13:52 |

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|------|--------|--|---|----|----|---------------------|
| S262 | 2      | S228 and(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)   | USPAT   | OR | ON | 2009/06/29<br>13:53 |
| S263 | 0      | S262 and automatic adj defect and recognition and(detected\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3 or accept\$3)  | USPAT   | OR | ON | 2009/06/29<br>13:55 |
| S264 | 0      | S262 and user adj select\$3 and review and(storage or stored or memory or data adj file)   | USPAT   | OR | ON | 2009/06/29<br>13:56 |
| S265 | 0      | S262 and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or cod or camera)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast) | USPAT   | OR | ON | 2009/06/29<br>13:56 |
| S266 | 2      | S228 and(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)   | USPAT   | OR | ON | 2009/06/29<br>13:59 |
| S267 | 1      | S229 and(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)   | USPAT   | OR | ON | 2009/06/29<br>13:59 |
| S268 | 0      | S267 and automatic adj defect and recognition and(detected\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3 or accept\$3)  | USPAT   | OR | ON | 2009/06/29<br>13:59 |
| S269 | 0      | S267 and user adj select\$3 and review and(storage or stored or memory or data adj file)   | USPAT   | OR | ON | 2009/06/29<br>13:59 |
| S270 | 0      | S267 and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or cod or camera)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast) | USPAT   | OR | ON | 2009/06/29<br>14:00 |
| S271 | 733    | S230 and(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)   | USPAT   | OR | ON | 2009/06/29<br>14:01 |
| S272 | 5      | S271 and automatic adj defect and recognition and(detected\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3 or accept\$3)  | USPAT   | OR | ON | 2009/06/29<br>14:01 |
| S273 | 0      | S272 and user adj select\$3 and review and(storage or stored or memory or data adj file)   | USPAT   | OR | ON | 2009/06/29<br>14:01 |
| S274 | 0      | S272 and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or cod or camera)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast) | USPAT   | OR | ON | 2009/06/29<br>14:01 |
| S275 | 5      | S272 and(@ad<"20030712" or @tad<"20030712" or @prad<"20030712" or @ptad<"20030712")  | USPAT   | OR | ON | 2009/06/29<br>14:02 |
| S276 | 0      | S272 and user adj select\$3 and review and(storage or stored or memory or data adj file)   | USPAT   | OR | ON | 2009/06/29<br>14:03 |
| S277 | 599018 | (wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>14:04 |

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| S278 | 83     | defect and classification and knowledge adj database              | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/06/29<br>14:04 |
| S279 | 19     | S278 and (water\$1 or semiconductor\$1 or chip\$1 or substrat\$1) | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/06/29<br>14:04 |
| S280 | 12     | S279 and @ack<"20030712"  | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/06/29<br>14:04 |
| S281 | 3      | S280 and descriptor   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/06/29<br>14:04 |
| S282 | 685554 | S281 and select\$3 and review and data file                       | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/06/29<br>14:04 |
| S283 | 18     | S278 and select\$3 and review and data adj file                   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/06/29<br>14:04 |
| S284 | 17     | S283 and parameters   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/06/29<br>14:04 |
| S285 | 2      | S277 and S278 and S282 and S284                                   | US-PGRUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>JBM_TDB | OR | ON | 2009/06/29<br>14:04 |
| S286 | 0      | S285 and @ack<"20030712"  | USPAT   | OR | ON | 2009/06/29<br>14:04 |
| S288 | 129    | S231 and (water\$1 or semiconductor\$1 or chip\$1 or substrat\$1) | USPAT   | OR | ON | 2009/06/29<br>14:06 |

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|------|---|--|---|----|----|---------------------|
| S289 | 4 | S288 and user adj select\$3 and review and(storage or stored or memory or data adj file)   | USPAT   | OR | ON | 2009/06/29<br>14:06 |
| S290 | 0 | S289 and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or cod or camera)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast)   | USPAT   | OR | ON | 2009/06/29<br>14:07 |
| S291 | 0 | S289 and automatic adj defect and recognition and(detected\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3 or accept\$3)  | USPAT   | OR | ON | 2009/06/29<br>14:08 |
| S292 | 3 | S289 and(@ack<"20030712" or @lrad<"20030712" or @prad<"20030712" or @optad<"20030712")   | USPAT   | OR | ON | 2009/06/29<br>14:09 |
| S293 | 0 | S292 and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or cod or camera)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast)   | USPAT   | OR | ON | 2009/06/29<br>14:23 |
| S294 | 1 | S288 and automatic adj defect and recognition and(detected\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3 or accept\$3)  | USPAT   | OR | ON | 2009/06/29<br>14:26 |
| S295 | 0 | S294 and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or cod or camera)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast)   | USPAT   | OR | ON | 2009/06/29<br>14:26 |
| S296 | 0 | S294 and user adj select\$3 and review and(storage or stored or memory or data adj file)   | USPAT   | OR | ON | 2009/06/29<br>14:28 |
| S304 | 1 | ((wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1) and user adj select\$3 and review and data adj file and input and user and page and learning adj mode).dim.  | US-PGPUB  | OR | ON | 2009/06/29<br>14:51 |
| S306 | 1 | S294 and automatic adj defect and recognition and(detected\$3 or determining)and(defect or flaw or fault)and(assign\$3 or test\$3 or evaluat\$3 or accept\$3)  | USPAT   | OR | ON | 2009/06/29<br>14:55 |
| S307 | 0 | S306 and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or cod or camera)and(detected\$3 or determining)and(defect or flaw or fault)and (assign\$3 or test\$3 or evaluat\$3)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast)      | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>14:59 |
| S308 | 0 | S306 and select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or cod or camera)and(detected\$3 or determining)and(defect or flaw or fault)and (assign\$3 or test\$3 or evaluat\$3)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast)      | USPAT   | OR | ON | 2009/06/29<br>14:59 |
| S309 | 0 | accept\$3 adj select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or cod or camera)and(detected\$3 or determining)and(defect or flaw or fault)and (assign\$3 or test\$3 or evaluat\$3)and align\$4 and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast) | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>15:14 |
| S310 | 0 | accept\$3 adj select\$3 adj(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(capturing or pictures or cod or camera)and(detected\$3 or determining)and(defect or flaw or fault)and (assign\$3 or test\$3 or evaluat\$3)and(illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast)              | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>15:15 |

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| S311 | 0      | accept\$3 adj select\$3 adj (wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1) and (capturing or pictures or ccd or camera) and (detect\$3 or determining) and (defect or flaw or fault) and (assign\$3 or test\$3 or evaluat\$3) and (illumination or source or light or optimal adj intensity or light adj intensity or brightness or contrast) and threshold\$3   | US-PG&PUB;<br>USPAT; EPO;<br>JPO;<br>DERW&ENT;<br>IBM_TDB | OR | ON | 2009/06/29<br>15:17 |
| S312 | 599764 | (wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)   | US-PG&PUB;<br>USPAT; EPO;<br>JPO;<br>DERW&ENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:24 |
| S313 | 5      | S312 and (automatic adj defect adj classification or ADC) and knowledge adj based adj database   | US-PG&PUB;<br>USPAT; EPO;<br>JPO;<br>DERW&ENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:25 |
| S316 | 0      | S312 and (assign\$3 or test\$3 or evaluat\$3 or accept\$3) same select\$3 adj number same (defect or flaw or fault) same (plurality or plural\$1 or location or first adj wafer or wafer\$1) same (capturing or obtaining or generating or pictures or thumbnails adj image\$1 or display\$3) same (intensity or contrast or brightness or focus or out adj focus or illumination or source or light or optimal adj illuminat\$3)                                | US-PG&PUB;<br>USPAT; EPO;<br>JPO;<br>DERW&ENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:41 |
| S317 | 3      | S313 and (@ad< "20030712" or @rlad< "20030712" or @prad< "20030712" or @ptad< "20030712")  | US-PG&PUB;<br>USPAT; EPO;<br>JPO;<br>DERW&ENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:43 |
| S318 | 0      | S313 and @ad< "20030712"   | US-PG&PUB;<br>USPAT; EPO;<br>JPO;<br>DERW&ENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:43 |
| S319 | 0      | S313 and (assign\$3 or test\$3 or evaluat\$3 or accept\$3) same select\$3 adj number same (defect or flaw or fault) same (plurality or plural\$1 or location or first adj wafer or wafer\$1) same (capturing or obtaining or generating or pictures or thumbnails adj image\$1 or display\$3) same (intensity or contrast or brightness or focus or out adj focus or illumination or source or light or optimal adj illuminat\$3) and threshold same descriptors | US-PG&PUB;<br>USPAT; EPO;<br>JPO;<br>DERW&ENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:46 |
| S320 | 11250  | S313 and (assign\$3 or test\$3 or evaluat\$3 or accept\$3) and select\$3 adj number and (defect or flaw or fault) and (plurality or plural\$1 or location or first adj wafer or wafer\$1) and (capturing or obtaining or generating or pictures or thumbnails adj image\$1 or display\$3) and 0 (intensity or contrast or brightness or focus or out adj focus or illumination or source or light or optimal adj illuminat\$3) and threshold\$3 and descriptors  | US-PG&PUB;<br>USPAT; EPO;<br>JPO;<br>DERW&ENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:47 |
| S321 | 712    | S320 and (wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)  | US-PG&PUB;<br>USPAT; EPO;<br>JPO;<br>DERW&ENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:47 |



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| S322 | 1  | S321 and (automatic adj defect adj classification or ADC)and knowledge adj based adj database   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:48 |
| S325 | 47 | (wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and (assign\$3 or test\$3 or evaluat\$3 or accept\$3)and select\$3 adj number and(defect or flaw or fault)and(plurality or plural\$1 or location or first adj wafer or wafer\$1)and(capaturing or obtaining or generating or pictures or thumbnails adj image\$1 or display\$3)and(intensity or contrast or brightness or focus or out adj focus or illumination or source or light or optimal adj illuminat\$3)and threshold\$3 and descriptors  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:52 |
| S326 | 0  | S325 and (automatic adj defect adj classification or ADC)and knowledge adj based adj database   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:53 |
| S327 | 45 | S325 and(@ad<"20030712" or @rlad<"20030712" or @prad<"20030712" or @plad<"20030712")  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:53 |
| S328 | 4  | S325 and @ad<"20030712"   | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:53 |
| S329 | 7  | S312 and(assign\$3 or test\$3 or evaluat\$3 or accept\$3)same select\$3 adj number same (defect or flaw or fault)same(plurality or plural\$1 or location or first adj wafer or wafer\$1) same(capaturing or obtaining or generating or pictures or thumbnails adj image\$1 or display \$3)  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:57 |
| S330 | 0  | S329 and(@ad<"20030712" or @rlad<"20030712" or @prad<"20030712" or @plad<"20030712")  | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>11:57 |
| S332 | 0  | optimizat\$3 and detect\$3 adj parameters and(wafer\$1 or semiconductor\$1 or chip\$1 or substrat\$1)and(assign\$3 or test\$3 or evaluat\$3 or accept\$3)and select\$3 adj number and (defect or flaw or fault)and(plurality or plural\$1 or location or first adj wafer or wafer\$1)and (capaturing or obtaining or generating or pictures or thumbnails adj image\$1 or display\$3) and(intensity or contrast or brightness or focus or out adj focus or illumination or source or light or optimal adj illuminat\$3)and threshold\$3 and descriptors | US-PGPUB;<br>USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/07/02<br>12:02 |

7/2/09 1:36:25 PM

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